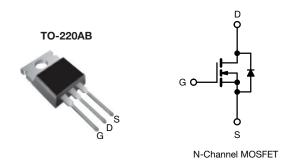


Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.061		
Q _g max. (nC)	189			
Q _{gs} (nC)	26			
Q _{gd} (nC)	55			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free and halogen-free	SiHP38N60EF-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current ($T_{,1} = 150 \ ^{\circ}C$)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	40		
Continuous drain current $(1) = 150^{\circ}$ C)	V _{GS} at 10 V	T _C = 100 °C		25	А	
Pulsed drain current ^a			I _{DM}	111		
Linear derating factor				2.5	W/°C	
Single pulse avalanche energy ^b			E _{AS}	508	mJ	
Maximum power dissipation			PD	313	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100) (/rea	
Reverse diode dv/dt ^d				50	V/ns	
Soldering recommendations (peak temperature) ^c For 10 s				260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. $V_{DD} = 140$ V, starting $T_J = 25$ °C, L = 28.2 mH, $R_q = 25 \Omega$, $I_{AS} = 6.0$ A

c. 1.6 mm from case

d. $I_{SD} = 23.5$ A, di/dt = 250 A/µs, starting $T_J = 25$ °C

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	40	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.4	0/10	

S20-0140-Rev. B, 16-Mar-2020

For technical questions, contact: hvm@vishay.com

Document Number: 92038



COMPLIANT

FREE

1

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•			•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.72	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2	-	4	V
		,	$V_{GS} = \pm 20 V$		-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{\rm GS} = \pm 30 \rm V$	-	-	± 1	μA
Zaus ante colta se duria sumant		V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	l _D = 23.5 A	-	0.061	0.070	Ω
Forward transconductance ^a		V _{DS} =	30 V, I _D = 23.5 A	-	13	-	S
Dynamic		•					
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	3576	-	
Output capacitance	Coss	,	$V_{\rm DS} = 100 \rm V,$	-	167	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	5	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	104	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	535	-	
Total gate charge	Qg			-	126	189	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 23.5 A, V _{DS} = 480 V		26	-	nC
Gate-drain charge	Q _{gd}	1		-	55	-	
Turn-on delay time	t _{d(on)}	V _{DD} = 480 V, I _D = 23.5 A,		-	35	70	
Rise time	t _r			-	63	126	- ns
Turn-off delay time	t _{d(off)}		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		143	286	
Fall time	t _f	1 1		-	67	134	
Gate input resistance	Rg	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	s	-					
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	40	
Pulsed diode forward current	I _{SM}			-	-	111	- A
Diode forward voltage	V _{SD}	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm S} = 23.5 \text{A}, V_{\rm GS} = 0 \text{V}$		-	-	1.2	V
Reverse recovery time	t _{rr}	Ť			160	320	ns
Reverse recovery charge	Q _{rr}	T _J = 25 °C, $I_F = I_S = 23.5 \text{ A}$, di/dt = 100 A/ μ s, $V_R = 400 \text{ V}$		-	1.2	2.4	μC
Reverse recovery current	I _{BBM}			-	14.3	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

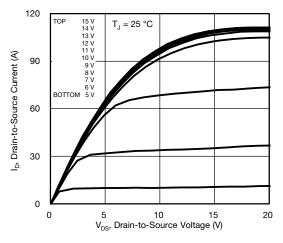
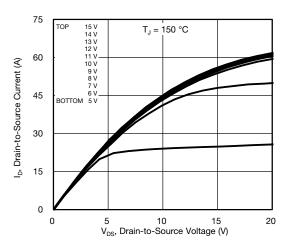


Fig. 1 - Typical Output Characteristics





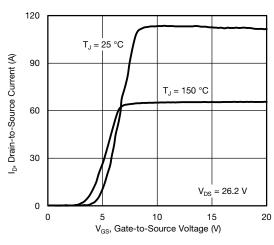


Fig. 3 - Typical Transfer Characteristics

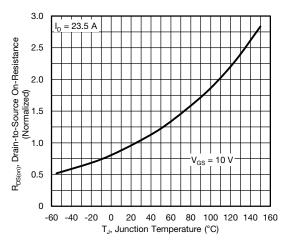


Fig. 4 - Normalized On-Resistance vs. Temperature

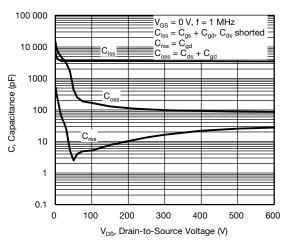


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

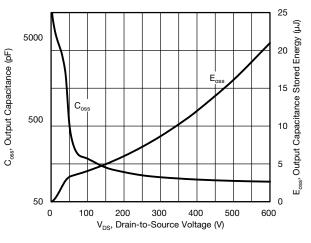


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S20-0140-Rev. B, 16-Mar-2020

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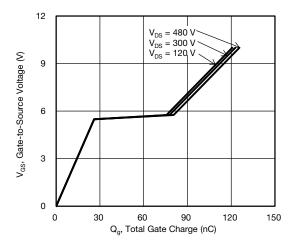


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

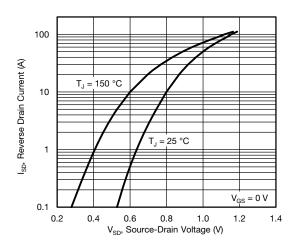
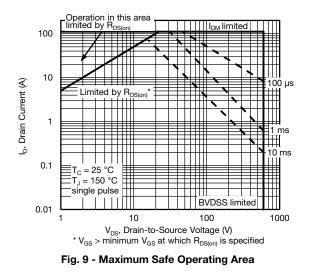


Fig. 8 - Typical Source-Drain Diode Forward Voltage



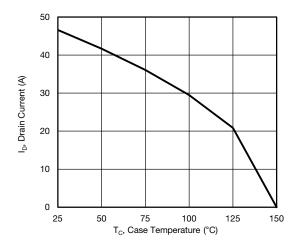


Fig. 10 - Maximum Drain Current vs. Case Temperature

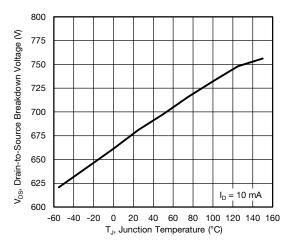


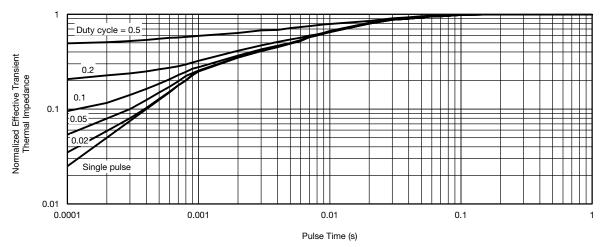
Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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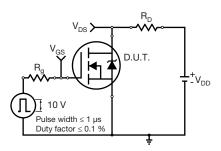


Fig. 13 - Switching Time Test Circuit

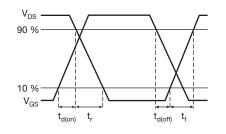


Fig. 14 - Switching Time Waveforms

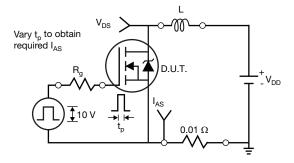


Fig. 15 - Unclamped Inductive Test Circuit

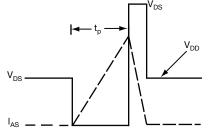


Fig. 16 - Unclamped Inductive Waveforms

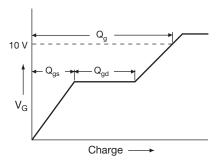


Fig. 17 - Basic Gate Charge Waveform

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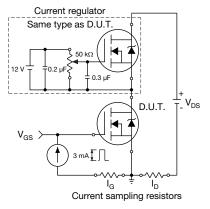
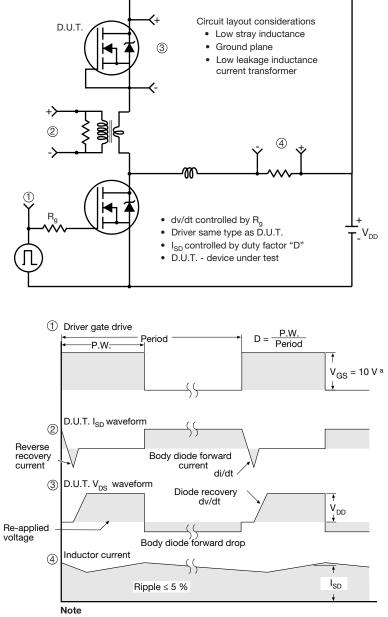


Fig. 18 - Gate Charge Test Circuit



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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
ASE		Xi	'an	
		IRF 9510 744K AB		

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